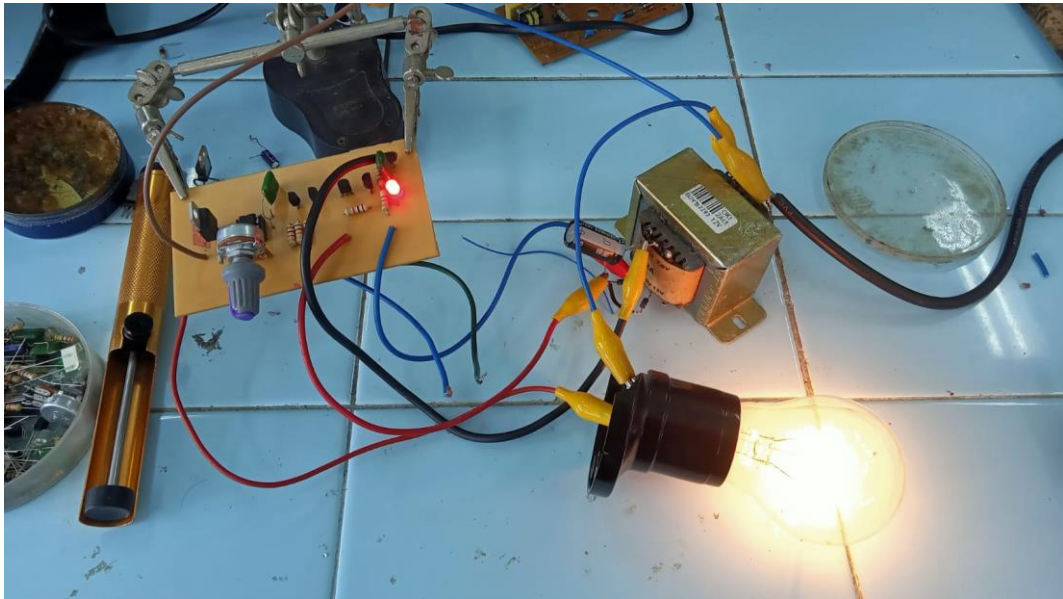
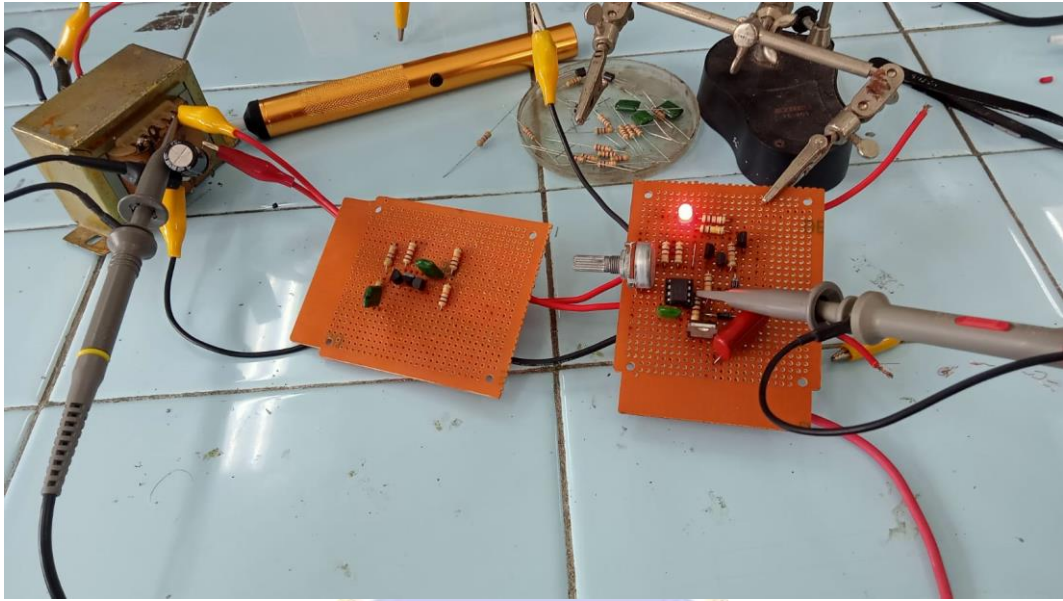


LAMPIRAN-LAMPIRAN

Lampiran 1. Dokumentasi







Lampiran 2. Data Sheet Komponen

KEC

SEMICONDUCTOR TECHNICAL DATA

KTC9014

EPITAXIAL PLANAR NPN TRANSISTOR

GENERAL PURPOSE APPLICATION.
SWITCHING APPLICATION.

FEATURES

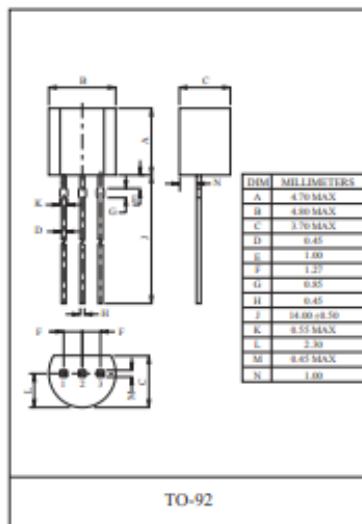
- Excellent h_{FE} Linearity
: $h_{FE}(I_C=0.1mA)/h_{FE}(I_C=2mA)=0.95(Typ.)$.
- Low Noise :NF=1dB(Typ.) at $f=1kHz$.
- Complementary to KTC9015.

MAXIMUM RATING (Ta=25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CB0}	60	V
Collector-Emitter Voltage	V_{CE0}	50	V
Emitter-Base Voltage	V_{EB0}	5	V
Collector Current	I_C	150	mA
Emitter Current	I_E	-150	mA
Collector Power Dissipation	P_C^*	625	mW
		400	
Junction Temperature	T_j	150	°C
Storage Temperature Range	T_{stg}	-55 ~ 150	°C

* Cu Lead-Frame : 625mW

Fe Lead-Frame : 400mW



ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	I_{CBO}	$V_{CE}=50V, I_E=0$	-	-	50	nA
Emitter Cut-off Current	I_{EBO}	$V_{EB}=5V, I_C=0$	-	-	100	nA
DC Current Gain	$h_{FE}(Note)$	$V_{CE}=5V, I_C=1mA$	60	-	1000	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=100mA, I_B=10mA$	-	0.1	0.25	V
Transition Frequency	f_T	$V_{CE}=10V, I_C=1mA, f=100MHz$	60	-	-	MHz
Collector Output Capacitance	C_{ob}	$V_{CE}=10V, I_C=0, f=1MHz$	-	2.0	3.5	pF
Noise Figure	NF	$V_{CE}=6V, I_C=0.1mA, R_g=10k\Omega, f=1kHz$	-	1.0	10	dB

Note : h_{FE} Classification A:60 ~ 150, B:100 ~ 300, C:200 ~ 600, D:400 ~ 1000

1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameters			Value	Unit	
$I_{T(RMS)}$	RMS on-state current (full sine wave)	D ² PAK / TO-220AB	$T_c = 100\text{ }^{\circ}\text{C}$	25	A	
		TO-220AB Ins.	$T_c = 75\text{ }^{\circ}\text{C}$			
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = $25\text{ }^{\circ}\text{C}$)	$f = 60\text{ Hz}$	$t_p = 16,7\text{ ms}$	260	A	
		$f = 50\text{ Hz}$	$t_p = 20\text{ ms}$	250		
I^2t	I^2t value for fusing	$t_p = 10\text{ ms}$		340	A^2s	
di/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ ns}$	$f = 120\text{ Hz}$	$T_j = 125\text{ }^{\circ}\text{C}$	50	$\text{A}/\mu\text{s}$	
V_{DSM}, V_{RSM}	Non repetitive surge peak off-state voltage	$t_p = 10\text{ ms}$	$T_j = 25\text{ }^{\circ}\text{C}$	$V_{DRM}, V_{RRM} + 100$	V	
V_{DRM}, V_{RRM}	Repetitive peak off-state voltage	$T_j = 25\text{ }^{\circ}\text{C}$		600 or 800	V	
I_{GM}	Peak gate current	$t_p = 20\text{ }\mu\text{s}$	$T_j = 125\text{ }^{\circ}\text{C}$	4	A	
$P_{G(AV)}$	Average gate power dissipation	$T_j = 125\text{ }^{\circ}\text{C}$		1	W	
T_{stg}	Storage junction temperature range				-40 to +150	$^{\circ}\text{C}$
T_j	Operating junction temperature range				-40 to +125	$^{\circ}\text{C}$
T_L	Maximum lead temperature for soldering during 10 s				260	$^{\circ}\text{C}$
V_{INS}	Insulation RMS voltage, 1 minute				2.5	kV

Table 2. Electrical characteristics ($T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) - Snubberless (3 quadrants) T25, BTA24-XXXXW, BTB24-XXXXW

Symbol	Parameters	Quadrant		T25	BTA/BTB		Unit
				T2535	CW	BW	
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$, $R_L = 33\text{ }\Omega$	I - II - III	Max.	35	35	50	mA
V_{GT}		I - II - III	Max.	1.3			V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3\text{ k}\Omega$, $T_j = 125\text{ }^{\circ}\text{C}$	I - II - III	Min.	0.2			V
$I_H^{(2)}$	$I_T = 500\text{ mA}$		Max.	50	50	75	mA
I_L	$I_G = 1.2\text{ }I_{GT}$	I - III	Max.	70	70	80	mA
		II	Max.	80	80	100	
$dV/dt^{(2)}$	$V_D = 67\text{ }\% V_{DRM}$ gate open, $T_j = 125\text{ }^{\circ}\text{C}$		Min.	500	500	1000	$\text{V}/\mu\text{s}$
$(di/dt)_c^{(2)}$	Without snubber		Min.	13	13	22	A/ms

1. Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.

2. For both polarities of A2 referenced to A1



**Table 3. Electrical characteristics ($T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) - standard (4 quadrants)
 BTB24-800B, BTB24-600B**

Symbol	Parameters	Quadrant		Value	Unit
$I_{GT}^{(1)}$	$V_D = 12\text{ V}, R_L = 33\text{ }\Omega$	I - II - III	Max.	50	mA
		IV		100	
V_{GT}		All	Max.	1.3	V
V_{GD}	$V_D = V_{DRM}, R_L = 3.3\text{ k}\Omega, T_J = 125\text{ }^{\circ}\text{C}$	All	Min.	0.2	V
$I_H^{(2)}$	$I_T = 500\text{ mA}$		Max.	80	mA
I_L	$I_G = 1.2\text{ }I_{GT}$	I - III - IV	Max.	70	mA
		II	Max.	160	
$dV/dt^{(2)}$	$V_D = 67\text{ }\% V_{DRM}$ gate open, $T_J = 125\text{ }^{\circ}\text{C}$		Min.	500	V/ μs
$(dV/dt)_C^{(2)}$	$(dI/dt)_C = 13.3\text{ A/ms}, T_J = 125\text{ }^{\circ}\text{C}$		Min.	10	V/ μs

1. Minimum I_{GT} is guaranteed at 5 % of I_{GT} max.
2. For both polarities of A2 referenced to A1

Table 4. Static electrical characteristics

Symbol	Test conditions	T_J		Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 35\text{ A}, I_p = 380\text{ }\mu\text{s}$	25 $^{\circ}\text{C}$	Max.	1.55	V
$V_{TO}^{(1)}$	threshold on-state voltage	125 $^{\circ}\text{C}$	Max.	0.85	V
$R_D^{(1)}$	Dynamic resistance	125 $^{\circ}\text{C}$	Max.	16	m Ω
I_{DRM}/I_{RRM}	$V_T = V_{DRM}, V_T = V_{RRM}$	25 $^{\circ}\text{C}$	Max.	5	μA
		125 $^{\circ}\text{C}$		3	mA

1. For both polarities of A2 referenced to A1

Table 5. Thermal resistance

Symbol	Parameters			Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	D ² PAK / TO-220AB	Max.	0.8	$^{\circ}\text{C/W}$
		TO-220AB insulated		1.7	
$R_{th(j-a)}$	Junction to ambient, $S^{(1)} = 2.5\text{ cm}^2$	D ² PAK	Typ.	45	
	Junction to ambient	TO-220AB / TO-220AB insulated		60	

1. S = Copper surface under tab.



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	BC546	80
		BC547 / BC550	50
		BC548 / BC549	30
V_{CEO}	Collector-Emitter Voltage	BC546	65
		BC547 / BC550	45
		BC548 / BC549	30
V_{EBO}	Emitter-Base Voltage	BC546 / BC547	6
		BC548 / BC549 / BC550	5
I_C	Collector Current (DC)	100	mA
P_C	Collector Power Dissipation	500	mW
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-65 to +150	$^\circ\text{C}$

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{CBO}	Collector Cut-Off Current	$V_{CB} = 30\text{ V}, I_E = 0$			15	nA
h_{FE}	DC Current Gain	$V_{CE} = 5\text{ V}, I_C = 2\text{ mA}$	110		800	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 10\text{ mA}, I_B = 0.5\text{ mA}$		90	250	mV
		$I_C = 100\text{ mA}, I_B = 5\text{ mA}$		250	600	
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 10\text{ mA}, I_B = 0.5\text{ mA}$		700		mV
		$I_C = 100\text{ mA}, I_B = 5\text{ mA}$		900		
$V_{BE(on)}$	Base-Emitter On Voltage	$V_{CE} = 5\text{ V}, I_C = 2\text{ mA}$	580	660	700	mV
		$V_{CE} = 5\text{ V}, I_C = 10\text{ mA}$			720	
f_T	Current Gain Bandwidth Product	$V_{CE} = 5\text{ V}, I_C = 10\text{ mA}, f = 100\text{ MHz}$		300		MHz
C_{ob}	Output Capacitance	$V_{CB} = 10\text{ V}, I_E = 0, f = 1\text{ MHz}$		3.5	6.0	pF
C_{ib}	Input Capacitance	$V_{EB} = 0.5\text{ V}, I_C = 0, f = 1\text{ MHz}$		9		pF
NF	Noise Figure	BC546 / BC547 / BC548	$V_{CE} = 5\text{ V}, I_C = 200\text{ }\mu\text{A}, f = 1\text{ kHz}, R_G = 2\text{ k}\Omega$	2.0	10.0	dB
		BC549 / BC550		1.2	4.0	
		BC549	$V_{CE} = 5\text{ V}, I_C = 200\text{ }\mu\text{A}, R_G = 2\text{ k}\Omega, f = 30\text{ to }15000\text{ MHz}$	1.4	4.0	
		BC550		1.4	3.0	

h_{FE} Classification

Classification	A	B	C
h_{FE}	110 ~ 220	200 ~ 450	420 ~ 800